

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Fusanobu Nakamur	10/30/2007
RECEIVING PARTY DATA	
Name:	LENOVO (Singapore) Pte. Ltd.
Street Address:	151 Lorong Chuan
Internal Address:	# 02-01
City:	Tech Park
State/Country:	SINGAPORE
Postal Code:	556741
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11927381
CORRESPONDENCE DATA	
Fax Number:	(801)531-1929
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	(801) 994-4646
Email:	hbabb@utahpatentlaw.com
Correspondent Name:	Brian C. Kunzler
Address Line 1:	8 East Broadway, Suite 600
Address Line 4:	Salt Lake City, UTAH 84111
ATTORNEY DOCKET NUMBER:	JP920062017US1
NAME OF SUBMITTER:	Brian C. Kunzler
Total Attachments: 1 source=JP920062017US1_Assignment#page1.tif	

CH \$40.00 11927381

500460758

PATENT
REEL: 020489 FRAME: 0375

PATENT

ASSIGNMENT

Whereas, I/ we,

(1) **Fusanobu Nakamura**
of Kanagawa-ken

City of Yamato-shi
Country of Japan

have invented certain improvements in

Title: **HOUSING TEMPERATURE SUPPRESSING STRUCTURE IN ELECTRONIC DEVICE AND
PORTABLE COMPUTER**

and executed a United States patent application therefor on the following date(s):

(1) 30 Oct 2007
(Date)

Whereas, **Lenovo (Singapore) Pte. Ltd.**, a corporation of Singapore, having a place of business at 151, Lorong Chuan #02-01, New Tech Park, Singapore 556741, (hereinafter called Lenovo), desires to acquire the entire right, title and interest in the application and invention, and to any United States and foreign patents to be obtained therefor;


Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I/we, the above named, hereby acknowledge my/our prior existing obligation and hereby sell, assign, and transfer to Lenovo, its successors and assigns, the entire right, title and interest in the application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of the United States application, and I/we request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in the application to Lenovo, its successors and assigns; and I/we hereby agree that Lenovo may apply for foreign Letters Patent on the invention and I/we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by Lenovo.

Signed and sealed:

CITY/STATE

DATE

SIGNATURE

(1) Yamato/Kanagawa 30 Oct 2007 
Fusanobu Nakamura

[Docket No.]
[U.S. Serial Number]

PATENT

RECORDED: 02/11/2008

REEL: 020489 FRAME: 0376